



RE933-04ST

- Epoxy fibre-glass FR4 1.50 mm
- Double-sided 35 µm Cu
- Plated through holes (PTH)
- Surface chem. Ni/Au with solder stop mask
- Adaption circuit board for TSSOP 20 designed in a single row
- Pitch: 0.65 mm (173 mil)
- Hole diameter 1.00 mm
- Size 15.40 x 27.70 mm